

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
FRANCESCO MICHIELIN	03/20/2018
PAL SZASZ	03/14/2018
FREDRIK MATTISSON	03/14/2018
RECEIVING PARTY DATA	
Name:	SONY MOBILE COMMUNICATIONS INC.
Street Address:	4-12-3 HIGASHI-SHINAGAWA
Internal Address:	SHINAGAWA-KU
City:	TOKYO
State/Country:	JAPAN
Postal Code:	140-0002
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16967625
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Address Line 4:	RALEIGH, NORTH CAROLINA 27627
ATTORNEY DOCKET NUMBER:	1516-625
NAME OF SUBMITTER:	SUSAN E. FREEDMAN
SIGNATURE:	/Susan E. Freedman/
DATE SIGNED:	08/05/2020
Total Attachments: 4	
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ASSIGNMENT

THIS ASSIGNMENT, made by us, **Francesco MICHIELIN**, having a mailing address of Schreiberstrasse 21, 70199 Stuttgart, Germany; **Pal SZASZ**, having a mailing address of Rudeboksvägen 195, 226 55 Lund, Sweden; and **Fredrik MATTISSON**, having a mailing address of Neversvägen 37, 224 79 Lund, Sweden;

WITNESSETH: That,

WHEREAS, we are joint inventors of certain new and useful improvements in **METHODS, DEVICES, AND COMPUTER PROGRAM PRODUCTS FOR IMPROVED MESH GENERATION IN CONSTRUCTED 3D IMAGES**, for which PCT International Application Serial No. **PCT/US2018/019377** was filed on **February 23, 2018**; and U.S. Patent Application No. **16/967,625** was filed on **08-05-2020** (we hereby authorize and request Myers Bigel, P.A., to insert the filing date and application number of said application when known or to file this Assignment concurrently with the application); and

WHEREAS, **Sony Mobile Communications Inc.**, a Japanese corporation having a principal office and place of business at 4-12-3 Higashi-Shinagawa, Shinagawa-ku, Tokyo, 140-0002, Japan, hereinafter referred to as assignee, is desirous of acquiring my entire right, title and interest in and to said invention as described in said application(s), and in and to any and all Letters Patent which shall be granted therefor in the United States of America and all foreign countries;

NOW, THEREFORE, To Whom It May Concern, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we have sold and by these presents do hereby sell, assign, transfer and convey unto said assignee, its successors and assigns, the entire right, title, and interest in and to the said invention and application(s), and in and to any and all continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues or other forms of protection thereof which may be granted therefor or thereon, for the full end of the term for which said Letters Patent may be granted along with any term extensions thereon or therefor, together with the right to claim the priority of said application in all foreign countries in accordance with the International Convention, the same to be held and enjoyed by said assignee, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by us if this assignment and sale had not been made.

We hereby request that said Letters Patent be issued in accordance with this assignment.

We further covenant and agree that, at the time of the execution and delivery of these presents, and to the extent not already assigned to the assignee, we possess full title to the invention and applications above-mentioned, and that we have the unencumbered right and authority to make this assignment.

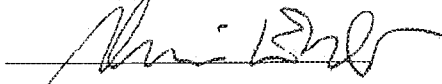
We further covenant and agree to promptly communicate to said assignee or its representatives any facts known to us relating to said invention, to testify in any interference or legal proceedings involving said invention, to execute any additional papers which may be requested to confirm the right of the assignee, its representatives, successors, or assigns to secure patent or similar protection for the said invention in all countries and to vest in the assignee complete title to the said invention and Letters Patent, without further compensation, but at the expense of said assignee, its successors, assigns, and other legal representatives; and we hereby instruct, and further covenant and agree to bind our heirs, legal representatives, and assigns, to do same, without further compensation, but at the expense of said assignee or its representatives.

IN WITNESS WHEREOF, I have hereunto set my hand and seal on this 20th day of MARCH, 2018.



Francesco MICHELIN (SEAL)

Witnessed by:



Date: 20.03.2018 Oliver Erdler, 911-019

IN WITNESS WHEREOF, I have hereunto set my hand and seal on this 14 day of
MARCH, 2018.

Pal Szasz (SEAL)
Pal SZASZ

Witnessed by:

Alatz Walz

Date: 2018/03/14

IN WITNESS WHEREOF, I have hereunto set my hand and seal on this 14 day of
March, 2018.

Fredrik Mattisson (SEAL)
Fredrik MATTISSON

Witnessed by:

Viktors Jakovels

Date: 2018-03-14